

Features

- Fast Switching
- Improved dv/dt Capability
- Split Gate Trench Mosfet Technology
- Excellent Package for Good Heat Dissipation
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

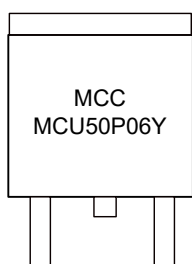
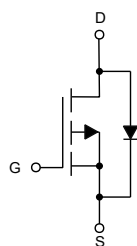
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 1.4°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-60	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	-50
		$T_C=100^\circ\text{C}$	-31
Pulsed Drain Current (Note 2)	I_{DM}	-200	A
Single Pulse Avalanche Energy (Note 3)	E_{AS}	169	mJ
Total Power Dissipation	P_D	89	W

Note:

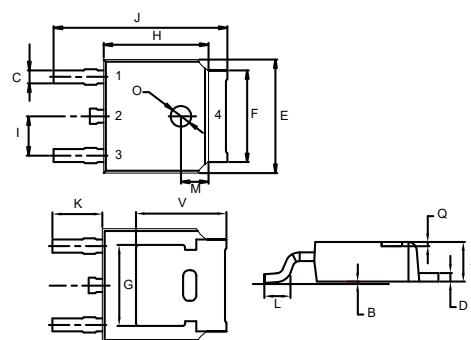
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. Pulse Width Limited by Maximum Junction Temperature.
3. EAS Condition: $T_J=25^\circ\text{C}$, $V_{DD}=-50\text{V}$, $V_G=-10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$, $I_{AS}=-26\text{A}$.

Internal Structure and Marking Code



P-CHANNEL MOSFET

DPAK(TO-252)



1. Gate
- 2,4. Drain
3. Source

DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.087	0.094	2.20	2.40	
B	0.000	0.005	0.00	0.13	
C	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
H	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.114		2.90		TYP.
L	0.047	0.069	1.20	1.75	
M	0.063		1.60		TYP.
O	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-60			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-60V, V_{GS}=0V$			-1	μA
		$V_{DS}=-60V, V_{GS}=0V, T_J=150^\circ C$			-100	
Gate-Threshold Voltage ^(Note 4)	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-2	-3	V
Drain-Source On-Resistance ^(Note 4)	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-25A$		9	12	m Ω
		$V_{GS}=-4.5V, I_D=-20A$		11	15	
Body Diode Voltage	V_{SD}	$I_S=-25A, V_{GS}=0V$		-0.9	-1.2	V
Gate resistance	R_G	f=1MHz, Open drain		8.5		Ω
Dynamic Characteristics^(Note 5)						
Input Capacitance	C_{iss}	$V_{DS}=-30V, V_{GS}=0V, f=1MHz$		4260		pF
Output Capacitance	C_{oss}			690		
Reverse Transfer Capacitance	C_{rss}			145		
Total Gate Charge	Q_g	$V_{DS}=-30V, V_{GS}=-10V, I_D=-25A$		79		nC
Gate-Source Charge	Q_{gs}			18		
Gate-Drain Charge	Q_{gd}			18		
Reverse Recovery Charge	Q_{rr}	$I_F=-25A, di/dt=100A/\mu s$		96		ns
Reverse Recovery Time	t_{rr}			52		
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=-30V, I_D=-25A, V_{GS}=-10V, R_G=3\Omega$		17		ns
Turn-On Rise Time	t_r			88		
Turn-Off Delay Time	$t_{d(off)}$			120		
Turn-Off Fall Time	t_f			110		

 Note 4. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 1.5\%$.

5. Guaranteed by Design, Not Subject to Production Testing.

Curve Characteristics

Fig. 1 - Typical Output Characteristics

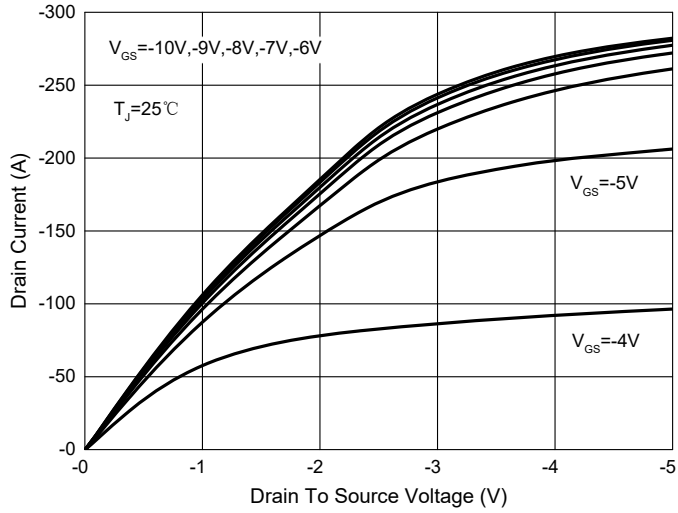


Fig. 2 - Transfer Characteristics

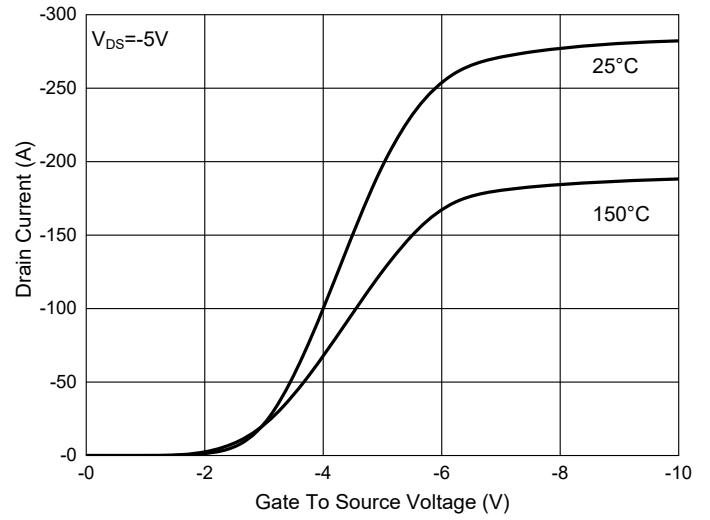


Fig. 3 - $R_{DS(ON)} - V_{GS}$

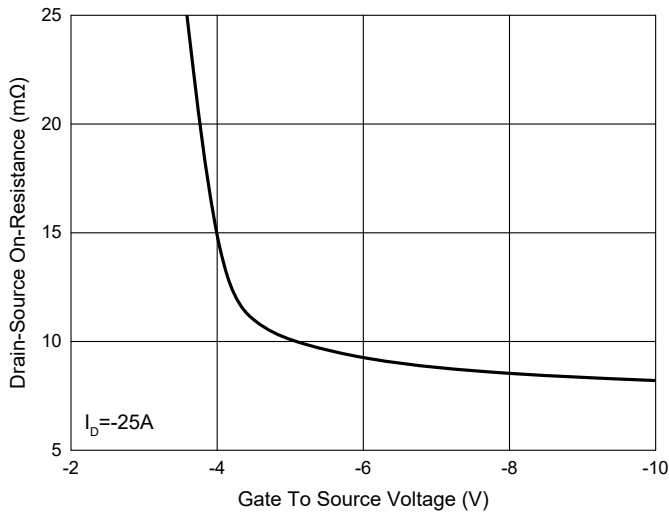


Fig. 4 - $I_S - V_{SD}$

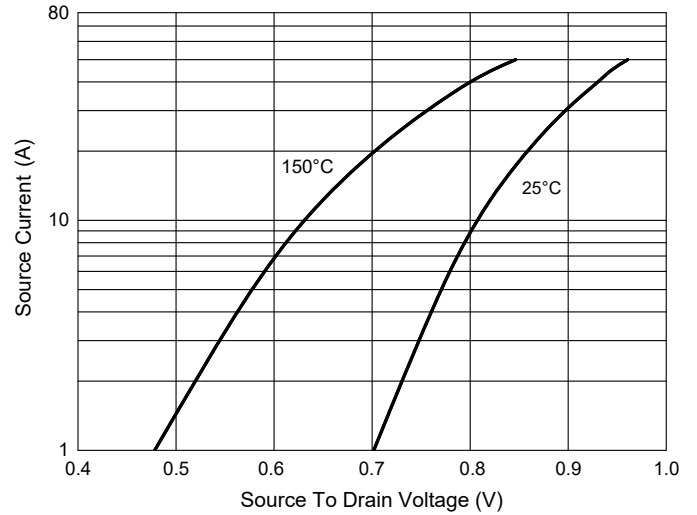


Fig. 5 - $R_{DS(ON)} - I_D$

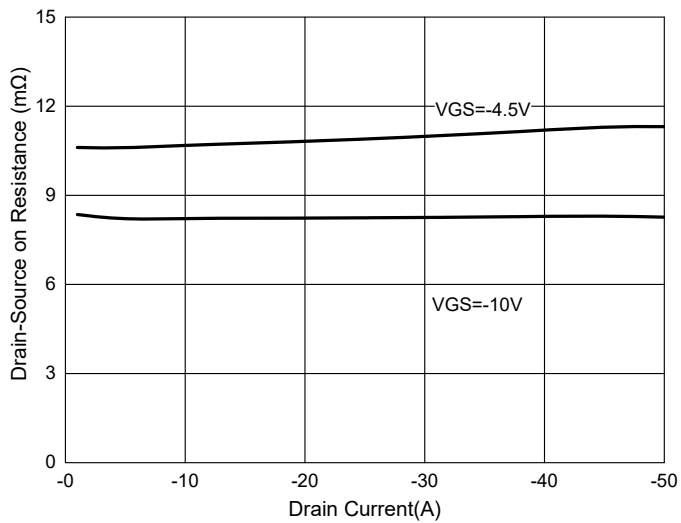
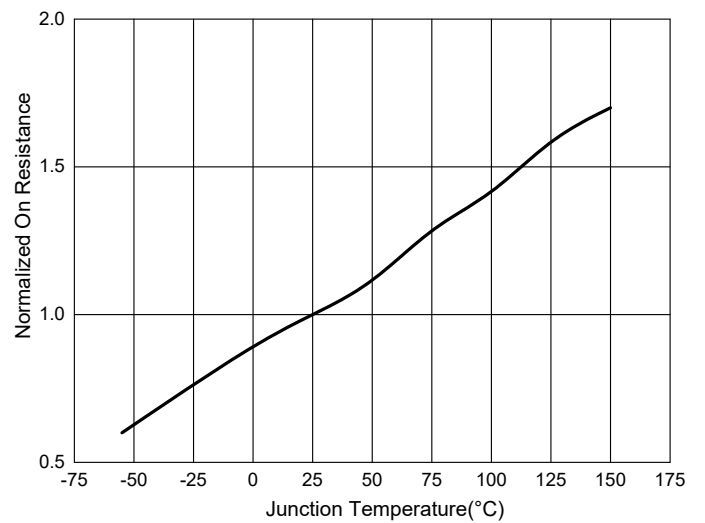


Fig. 6 - Normalized On Resistance Characteristics



Curve Characteristics

Fig. 7 - Capacitance Characteristics

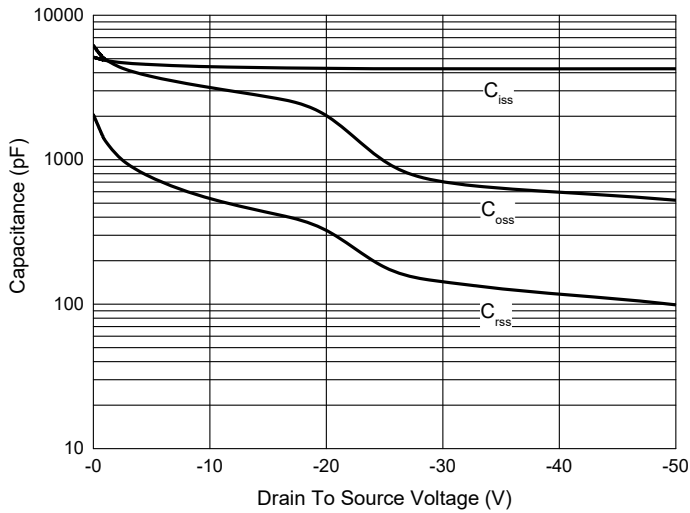


Fig. 8 - Gate Charge

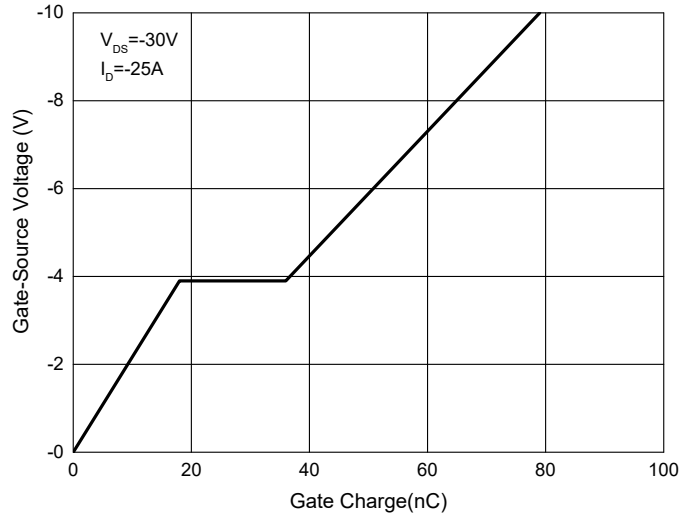


Fig. 9 - Power dissipation

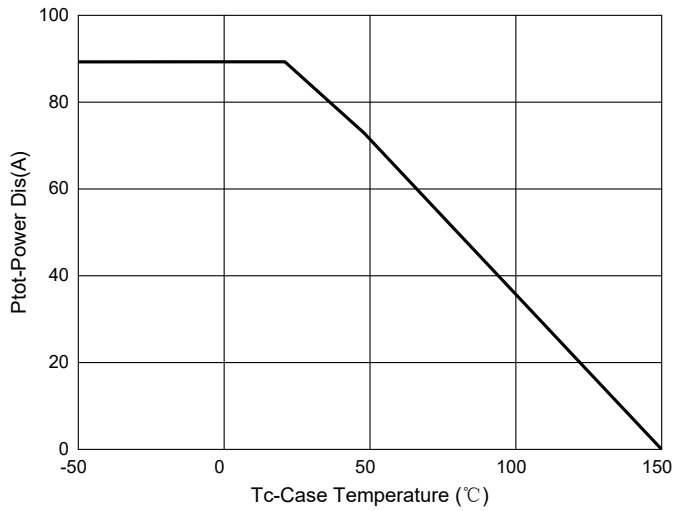


Fig. 10 - Safe Operation Area

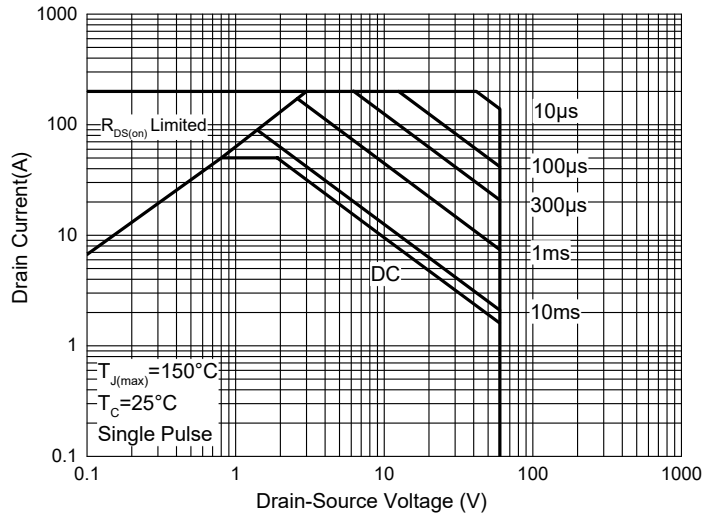
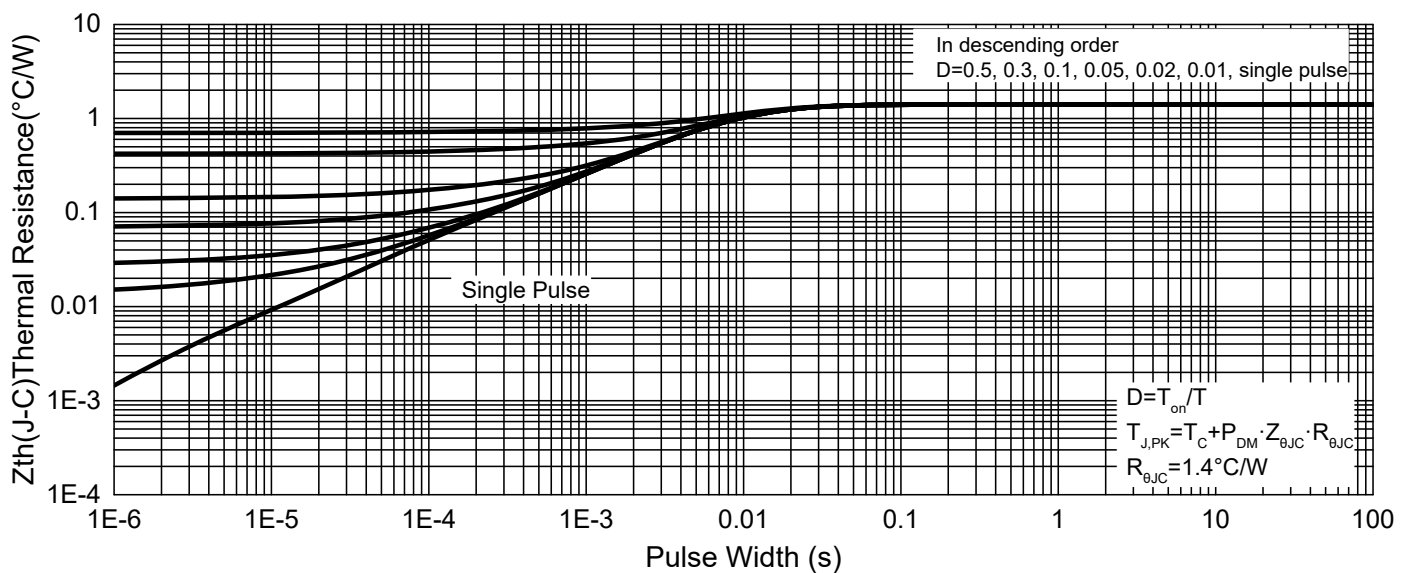


Fig. 11 - Maximum Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

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